



FDP5N50NZU / FDPF5N50NZU N-Channel MOSFET 500V, 3.9A, 2.0Ω

Features

- $R_{DS(on)} = 1.7\Omega$ (Typ.)@ $V_{GS} = 10V$, $I_D = 1.95A$
- Low Gate Charge (Typ. 9nC)
- Low C_{rss} (Typ. 4pF)
- Fast Switching
- 100% Avalanche Tested
- Improved dv/dt Capability
- ESD Imoroved Capability
- RoHS Compliant



Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

February 2012 UniFET-II[™]

This advance technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficient switching mode power supplies and active power factor correction.



MOSFET Maximum Ratings T_C = 25°C unless otherwise noted*

Symbol	Parameter			FDP5N50NZU	FDPF5N50NZU	Units
V _{DSS}	Drain to Source Voltage		500		V	
V _{GSS}	Gate to Source Voltage			±25		V
I _D	Drain Current	-Continuous (T _C	-Continuous ($T_C = 25^{\circ}C$) -Continuous ($T_C = 100^{\circ}C$)		3.9*	٨
	Drain Current	-Continuous (T _C			2.3*	A
I _{DM}	Drain Current	- Pulsed	(Note 1)	15	15*	А
E _{AS}	Single Pulsed Avalanche Energy		(Note 2)	135		mJ
I _{AR}	Avalanche Current		(Note 1)	3.9		А
E _{AR}	Repetitive Avalanche Energy		(Note 1)	7.8		mJ
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	20		V/ns
P _D	Dower Dissinction	$(T_{C} = 25^{\circ}C)$		78	30	W
	Power Dissipation	- Derate above 2	25°C	0.62	0.24	W/ºC
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150		°C	
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300		°C

Thermal Characteristics

Symbol	Parameter	FDP5N50NZU	FDPF5N50NZU	Units
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	1.6	4.1	
$R_{\theta CS}$	Thermal Resistance, Case to Heat Sink Typ.	0.5	-	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	62.5	62.5	

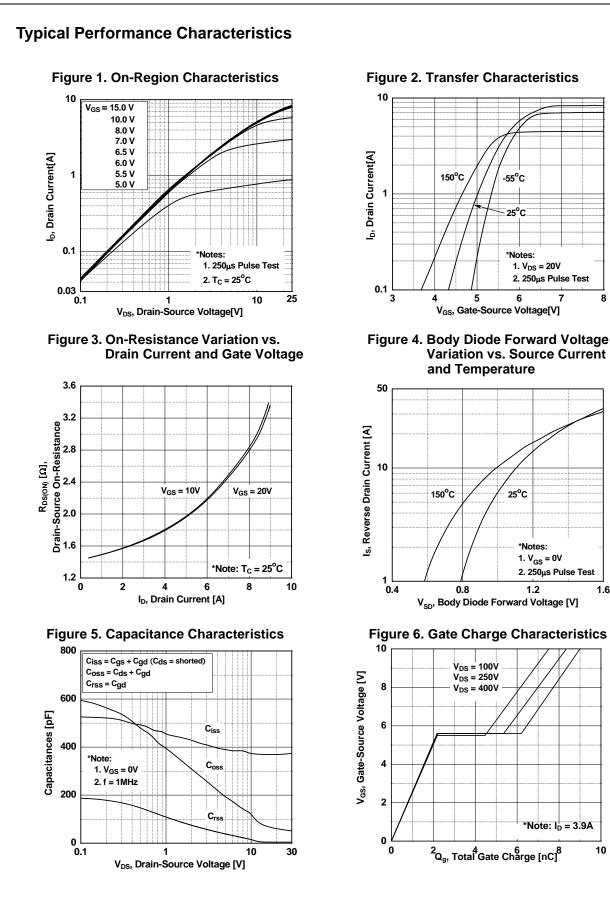
Device Marking Devic		Device	Package	e Reel Size	Таре	e Width		Quantit	y
FDP5N50NZU FDP5N50NZU		TO-220	-		-		50	•	
FDPF5N50NZU FDPF5N50NZU TC		TO-220F	-		-		50		
Electrica	I Char	acteristics T _c =	25ºC unless o	therwise noted					
Symbol		Parameter		Test Conditions		Min.	Тур.	Max.	Units
Off Charac	teristic	s							
BV _{DSS}	Drain to Source Breakdown Voltage		$I_D = 250\mu A, V_{GS} = 0V, T_C = 25^{\circ}C$		500	-	-	V	
ΔBV _{DSS} ΔTJ	Breakdown Voltage Temperature Coefficient		Iro	$I_D = 250 \mu A$, Referenced to $25^{\circ}C$		-	0.5	-	V/ºC
,	Zara C			$V_{DS} = 500V, V_{GS} = 0V$		-	-	25	•
IDSS	Zero Gate Voltage Drain Current		ent	$V_{DS} = 400V, V_{GS} = 0V, T_C = 125^{\circ}C$		-	-	250	μA
I _{GSS}	Gate to	te to Body Leakage Current		$V_{GS} = \pm 25V, V_{DS} = 0V$		-	-	±10	μA
On Charad	teristic	S							
V _{GS(th)}	Gate T	Gate Threshold Voltage		V _{GS} = V _{DS} , I _D = 250μA		3.0	-	5.0	V
R _{DS(on)}	Static D	tic Drain to Source On Resistance		$V_{GS} = 10V, I_D = 1.95A$		-	1.7	2.0	Ω
9 _{FS}	Forwar	Forward Transconductance		$V_{DS} = 20V, I_D = 1.95A$ (Note 4)		-	4.2	-	S
Dynamic (C _{iss} C _{oss}	Input C Output	apacitance Capacitance		V _{DS} = 25V, V _{GS} = 0V f = 1MHz		-	365 50	485 65	pF pF
C _{rss}	Reverse	e Transfer Capacitance				-	4	8	pF
Q _{g(tot)}		ate Charge at 10V			-	-	9	12	nC
Q _{gs}	Gate to	to Source Gate Charge		$V_{DS} = 400 V I_{D} = 3.9 A$ $V_{GS} = 10 V$		-	2	-	nC
Q _{gd}	Gate to	Drain "Miller" Charge		(Note 4)		-	4	-	nC
Switching	Charac	teristics							
t _{d(on)}	-	n Delay Time		$V_{DD} = 250V, I_D = 3.9A$ $V_{GS} = 10V, R_{GEN} = 25Ω$		-	12	35	ns
t _r	Turn-Or	n Rise Time				-	19	50	ns
t 1/ 10	Turn-Of	f Delay Time				-	31	70	ns
•a(oπ)	Turn-Of	Turn-Off Fall Time		(Note 4)		-	22	55	ns
			L.						
t _f	rce Dio	de Characteristic	S						
^t Drain-Sou		de Characteristic	-	Forward Current		-	-	3.9	Α
t _f Drain-Sou I _S	Maximu		Source Diode			-	-	3.9 15	A A
^t f Drain-Sou I _S I _{SM}	Maximu Maximu	m Continuous Drain to	Source Diode rce Diode Forv						_
I _S	Maximu Maximu Drain to	m Continuous Drain to m Pulsed Drain to Sou	Source Diode rce Diode Forv Voltage	vard Current		-	-	15	Α

Notes: 1. Repetitive Rating: Pulse width limited by maximum junction temperature

2. L = 18mH, I_{AS} = 3.9A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25°C

3. $I_{SD} \leq$ 3.9A, di/dt \leq 200A/µs, $V_{DD} \leq$ BV_{DSS}, Starting T_J = 25°C

4. Essentially Independent of Operating Temperature Typical Characteristics



*Notes: 1. $V_{GS} = 0V$ 2. 250µs Pulse Test

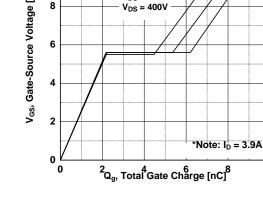
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Figure 6. Gate Charge Characteristics

V_{DS} = 100V

 $V_{DS} = 250V$

0.8



150°C

5

-55°C

25°C

*Notes:

6

25°C

V_{GS}, Gate-Source Voltage[V]

1. V_{DS} = 20V

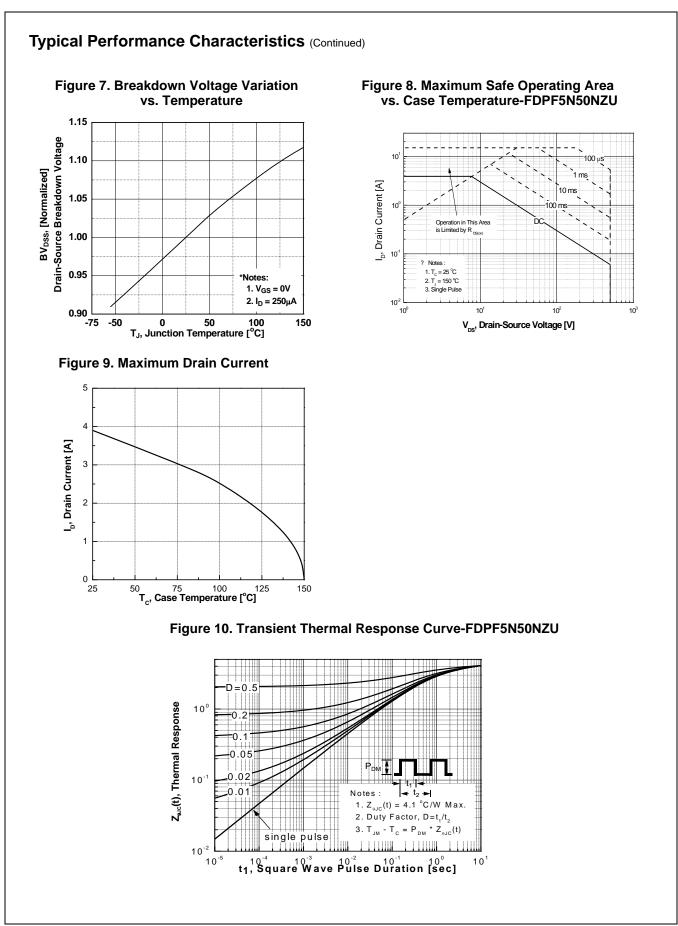
2. 250µs Pulse Test

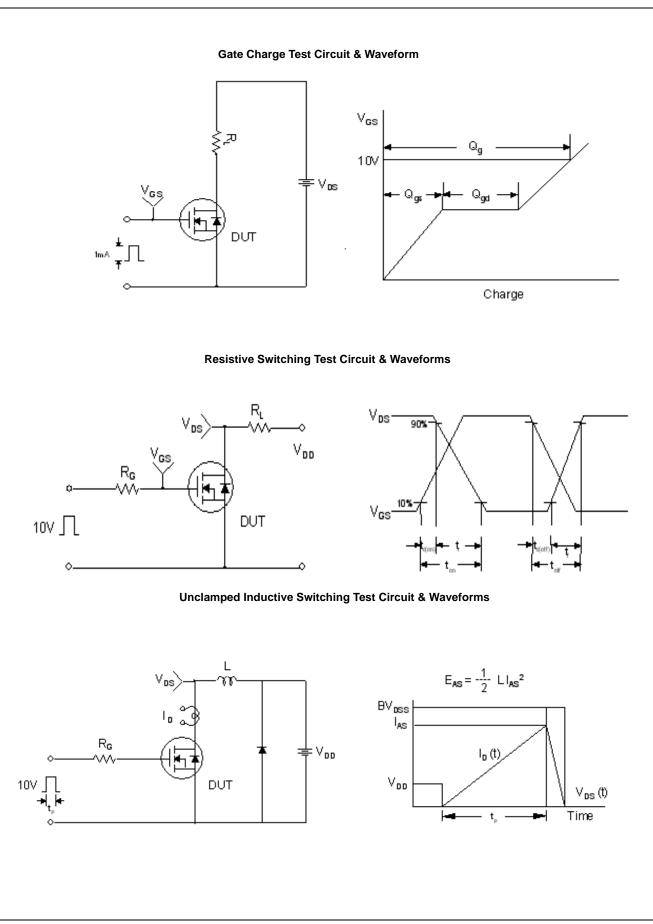
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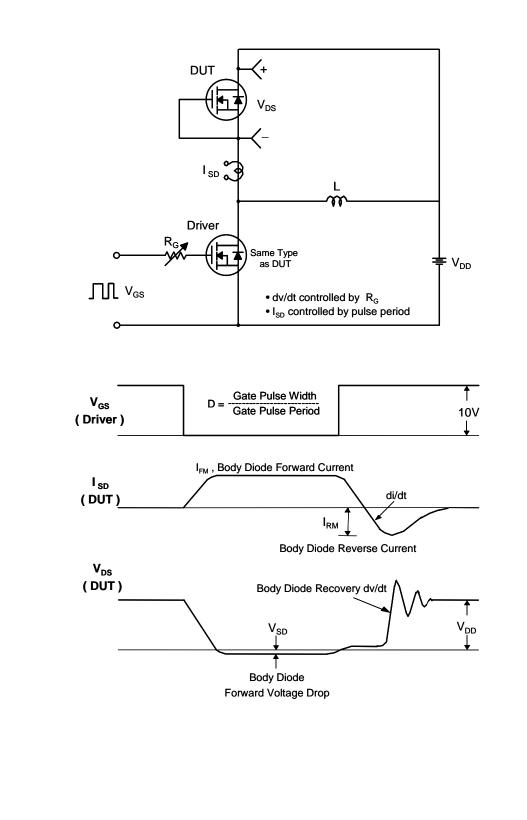
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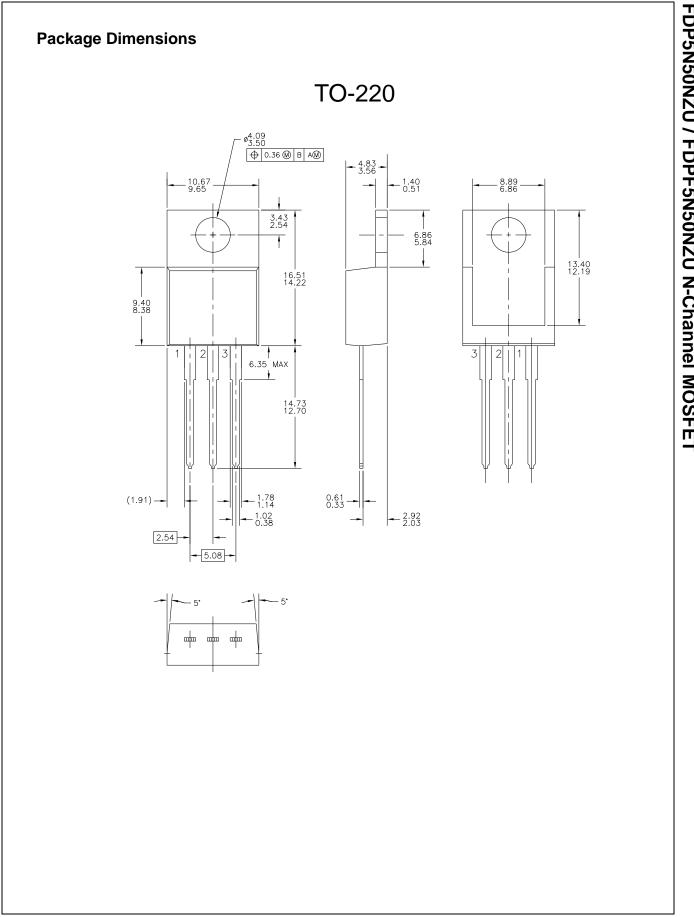


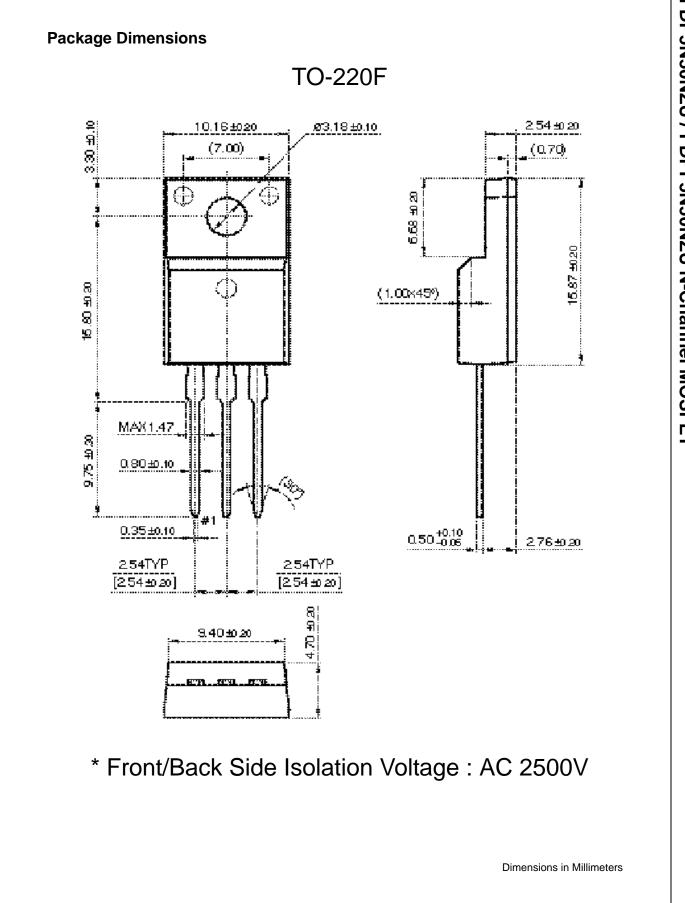


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Peak Diode Recovery dv/dt Test Circuit & Waveforms









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